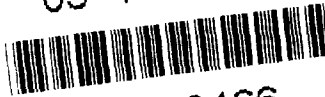


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To the Director of the United States Pat

Patent Office: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Ki-Chan LEE

2. Name and address of receiving party(ies):

Name: SAMSUNG ELECTRONICS CO., LTD.

Address: 416, Maetan-dong, Yeongtong-gu

Additional names(s) of conveying party(ies)

☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other

City: Suwon-si

State/Prov.: Gyeonggi-do

Country: Korea

ZIP:

Execution Date: January 4, 2006

Additional name(s) & address(es)

☐ Yes ☒ No

4. Application number(s) or patent numbers(s):

If this document is being filed together with a new application, the execution date of the application is: January 4, 2006

Patent Application No.

Filing date

B. Patent No.(s)

03/14/2006 DBYRNE 00000050 061130 11369119

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Additional numbers

☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Amy Bizoin-Copp

Registration No. 53,993

Address: Cantor Colburn LLP

55 Griffin Road South

City: Bloomfield

State/Prov.: CT

Country: USA

ZIP: 06002

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$ 40.00

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To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Amy Bizoin-Copp

Name of Person Signing

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March 6, 2006

Date

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ASSIGNMENT

WHEREAS I, **Lee, Ki-Chan** (hereinafter referred to as "ASSIGNOR") of **541-103 Sinnamusil 5-danji Ssangyong apt., Yeongtong-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Korea**; have invented certain new and useful improvements in:

THIN FILM PANEL, DRIVING DEVICE, AND LIQUID CRYSTAL DISPLAY HAVING THE SAME

which claims priority to Korean Application No. 10-2005-0019133, filed on March 8, 2005, and for which I am about to file an application for Letters Patent of the United States;

AND WHEREAS, **SAMSUNG ELECTRONICS CO., LTD.** (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of Korea, having a place of business at **416 Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Korea**, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for good and valuable consideration, the receipt of which is hereby acknowledged, I, the said ASSIGNOR, have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and I do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that I will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: 2008-1-4

Ki-Chan Lee L.S.
Lee, Ki-Chan